



**Maximum Ratings**<sup>[2,3]</sup>

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature ..... -65°C to +150°C  
 Ambient Temperature with Power Applied ..... -65°C to +135°C  
 Supply Voltage to Ground Potential ..... -0.5V to +7.0V  
 DC Input Voltage ..... -0.5V to +7.0V  
 DC Output Voltage ..... -0.5V to +7.0V  
 DC Output Current (Maximum Sink Current/Pin) ..... 120 mA  
 Power Dissipation ..... 0.5W

Static Discharge Voltage ..... > 2001V (per MIL-STD-883, Method 3015)

**Operating Range**

Range	Range	Ambient Temperature	V <sub>CC</sub>
Commercial	CT, DT	0°C to +70°C	5V ± 5%
Commercial	T, AT	-40°C to +85°C	5V ± 5%
Military <sup>[4]</sup>	All	-55°C to +125°C	5V ± 10%

**Electrical Characteristics Over the Operating Range**

Parameter	Description	Test Conditions	Min.	Typ. <sup>[5]</sup>	Max.	Unit	
V <sub>OH</sub>	Output HIGH Voltage	V <sub>CC</sub> =Min., I <sub>OH</sub> =-32 mA	Com'l	2.0		V	
		V <sub>CC</sub> =Min., I <sub>OH</sub> =-15 mA	Com'l	2.4	3.3	V	
		V <sub>CC</sub> =Min., I <sub>OH</sub> =-12 mA	Mil	2.4	3.3	V	
V <sub>OL</sub>	Output LOW Voltage	V <sub>CC</sub> =Min., I <sub>OL</sub> =64 mA	Com'l		0.3	0.55	V
		V <sub>CC</sub> =Min., I <sub>OL</sub> =48 mA	Mil		0.3	0.55	V
V <sub>IH</sub>	Input HIGH Voltage		2.0			V	
V <sub>IL</sub>	Input LOW Voltage				0.8	V	
V <sub>HI</sub>	Hysteresis <sup>[6]</sup>	All inputs		0.2		V	
V <sub>IK</sub>	Input Clamp Diode Voltage	V <sub>CC</sub> =Min., I <sub>IN</sub> =-18 mA		-0.7	-1.2	V	
I <sub>I</sub>	Input HIGH Current	V <sub>CC</sub> =Max., V <sub>IN</sub> =V <sub>CC</sub>			5	μA	
I <sub>IH</sub>	Input HIGH Current	V <sub>CC</sub> =Max., V <sub>IN</sub> =2.7V			±1	μA	
I <sub>IL</sub>	Input LOW Current	V <sub>CC</sub> =Max., V <sub>IN</sub> =0.5V			±1	μA	
I <sub>OS</sub>	Output Short Circuit Current <sup>[7]</sup>	V <sub>CC</sub> =Max., V <sub>OUT</sub> =0.0V	-60	-120	-225	mA	
I <sub>OFF</sub>	Power Off Disable	V <sub>CC</sub> =0V, V <sub>OUT</sub> =4.5V			±1	μA	

**Capacitance<sup>[6]</sup>**

Parameter	Description	Typ. <sup>[5]</sup>	Max.	Unit
C <sub>IN</sub>	Input Capacitance	5	10	pF
C <sub>OUT</sub>	Output Capacitance	9	12	pF

**Notes:**

- Unless otherwise noted, these limits are over the operating free air temperature range.
- Unused inputs must always be connected to an appropriate logic voltage level, preferably either V<sub>CC</sub> or ground.
- T<sub>A</sub> is the "instant on" case temperature.
- Typical values are at V<sub>CC</sub>=5.0V, T<sub>A</sub>=+25°C ambient.
- This parameter is guaranteed but not tested.
- Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect operational values. Otherwise prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parametric tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.

**Power Supply Characteristics**

Parameter	Description	Test Conditions	Typ. <sup>[3]</sup>	Max.	Unit
$I_{CC}$	Quiescent Power Supply Current	$V_{CC} = \text{Max.}, V_{IN} \leq 0.2V,$ $V_{IN} \geq V_{CC} - 0.2V$	0.1	0.2	mA
$\Delta I_{CC}$	Quiescent Power Supply Current (TTL inputs HIGH)	$V_{CC} = \text{Max.}, V_{IN} = 3.4V$ <sup>[8]</sup> $f_1 = 0, \text{Outputs Open}$	0.5	2.0	mA
$I_{CCD}$	Dynamic Power Supply Current <sup>[9]</sup>	$V_{CC} = \text{Max.}, \text{One Input Toggling},$ $50\% \text{ Duty Cycle, Outputs Open},$ $T/R \text{ or } \overline{OE} = \text{GND and}$ $V_{IN} \leq 0.2V \text{ or } V_{IN} \geq V_{CC} - 0.2V$	0.06	0.12	mA/ MHz
$I_C$	Total Power Supply Current <sup>[10]</sup>	$V_{CC} = \text{Max.},$ $50\% \text{ Duty Cycle, Outputs Open},$ $\text{One Bit Toggling at } f_1 = 10 \text{ MHz},$ $T/R \text{ or } \overline{OE} = \text{GND and}$ $V_{IN} \leq 0.2V \text{ or } V_{IN} \geq V_{CC} - 0.2V$	0.7	1.4	mA
		$V_{CC} = \text{Max.},$ $50\% \text{ Duty Cycle, Outputs Open},$ $\text{One Bit Toggling at } f_1 = 10 \text{ MHz},$ $T/R \text{ or } \overline{OE} = \text{GND and}$ $V_{IN} = 3.4V \text{ or } V_{IN} = \text{GND}$	1.2	3.4	mA
		$V_{CC} = \text{Max.},$ $50\% \text{ Duty Cycle, Outputs Open},$ $\text{Eight Bits Toggling at } f_1 = 2.5 \text{ MHz},$ $T/R \text{ or } \overline{OE} = \text{GND and}$ $V_{IN} \leq 0.2V \text{ or } V_{IN} \geq V_{CC} - 0.2V$	1.3	2.6 <sup>[11]</sup>	mA
		$V_{CC} = \text{Max.},$ $50\% \text{ Duty Cycle, Outputs Open},$ $\text{Eight Bits Toggling at } f_1 = 2.5 \text{ MHz},$ $T/R \text{ or } \overline{OE} = \text{GND and}$ $V_{IN} = 3.4V \text{ or } V_{IN} = \text{GND}$	3.3	10.6 <sup>[11]</sup>	mA

**Notes:**

- Per TTL driven input ( $V_{IN} = 3.4V$ ); all other inputs at  $V_{CC}$  or GND.
- This parameter is not directly testable, but is derived for use in Total Power Supply calculations.
- $I_C = I_{CC} + \Delta I_{CC} + I_{CCD}$   
 $I_C = I_{CC} + \Delta I_{CC} (D_{IH} N_I) + I_{CCD} (f_1/2 + f_1 N_I)$   
 $I_{CC} = \text{Quiescent Current with CMOS input levels}$   
 $\Delta I_{CC} = \text{Power Supply Current for a TTL HIGH input}$   
 $(V_{IN} = 3.4V)$   
 $D_{IH} = \text{Duty Cycle for TTL inputs HIGH}$

- $N_I = \text{Number of TTL inputs at } D_{IH}$
  - $I_{CCD} = \text{Dynamic Current caused by an input transition pair (HLH or LHL)}$
  - $f_1 = \text{Clock frequency for registered devices, otherwise zero}$
  - $f_1 = \text{Input signal frequency}$
  - $N_I = \text{Number of inputs changing at } f_1$
- All currents are in milliamps and all frequencies are in megahertz.
- Values for these conditions are examples of the  $I_{CC}$  formula. These limits are guaranteed but not tested.



Switching Characteristics over the Operating Range

Parameter	Description	FCT245T				FCT245AT				Unit	Fig. No. <sup>[13]</sup>
		Military		Commercial		Military		Commercial			
		Min. <sup>[12]</sup>	Max.	Min. <sup>[12]</sup>	Max.	Min. <sup>[12]</sup>	Max.	Min. <sup>[12]</sup>	Max.		
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay A to B or B to A	1.5	7.5	1.5	7.0	1.5	4.9	1.5	4.6	ns	1, 3
t <sub>PZH</sub> t <sub>PZL</sub>	Output Enable Time OE or T/R to A or B	1.5	10.0	1.5	9.5	1.5	6.5	1.5	6.2	ns	1, 7, 8
t <sub>PAZ</sub> t <sub>PLZ</sub>	Output Disable Time OE or T/R to A or B	1.5	10.0	1.5	7.5	1.5	6.0	1.5	5.0	ns	1, 7, 8

Switching Characteristics Over the Operating Range

Parameter	Description	FCT245CT				FCT245DT		Unit	Fig. No. <sup>[13]</sup>
		Military		Commercial		Commercial			
		Min. <sup>[12]</sup>	Max.	Min. <sup>[12]</sup>	Max.	Min. <sup>[12]</sup>	Max.		
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay A to B or B to A	1.5	4.5	1.5	4.1	1.5	3.8	ns	1, 3
t <sub>PZH</sub> t <sub>PZL</sub>	Output Enable Time OE or T/R to A or B	1.5	6.2	1.5	5.8	1.5	5.0	ns	1, 7, 8
t <sub>PAZ</sub> t <sub>PLZ</sub>	Output Disable Time OE or T/R to A or B	1.5	5.2	1.5	4.8	1.5	4.3	ns	1, 7, 8

Shaded areas contain preliminary information.

Notes:

- 12. Minimum limits are guaranteed but not tested on Propagation Delays.
- 13. See "Parameter Measurement Information" in the General Information Section.



Ordering Information

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
3.8	CY74FCT245DTQC	Q5	20-Lead (150-Mil) QSOP	Commercial
	CY74FCT245DTSOC	S5	20-Lead (300-Mil) Molded SOIC	
4.1	CY74FCT245CTPC	P5	20-Lead (300-Mil) Molded DIP	Commercial
	CY74FCT245CTQC	Q5	20-Lead (150-Mil) QSOP	
	CY74FCT245CTSOC	S5	20-Lead (300-Mil) Molded SOIC	
4.5	CY54FCT245CTDMB	D6	20-Lead (300-Mil) CerDIP	Military
	CY54FCT245CTLMB	L61	20-Square Leadless Chip Carrier	
4.6	CY74FCT245ATPC	P5	20-Lead (300-Mil) Molded DIP	Commercial
	CY74FCT245ATQC	Q5	20-Lead (150-Mil) QSOP	
	CY74FCT245ATSOC	S5	20-Lead (300-Mil) Molded SOIC	
4.9	CY54FCT245ATDMB	D6	20-Lead (300-Mil) CerDIP	Military
	CY54FCT245ATLMB	L61	20-Square Leadless Chip Carrier	
7.0	CY74FCT245TPC	P5	20-Lead (300-Mil) Molded DIP	Commercial
	CY74FCT245TQC	Q5	20-Lead (150-Mil) QSOP	
	CY74FCT245TSOC	S5	20-Lead (300-Mil) Molded SOIC	
7.5	CY54FCT245TDMB	D6	20-Lead (300-Mil) CerDIP	Military
	CY54FCT245TLMB	L61	20-Square Leadless Chip Carrier	

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